TOSHIBA SH400R32B

TOSHIBA ALLOY-FREE HIGHT SPEED THYRISTOR

S H 4 O O R 3 2 B

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage : V_{DRM} = 1300V

Repetitive Peak Reverse Voltage: VRRM

 $: I_{T(AV)} = 400A$ Average On-State Current

Turn-Off Time : $t_0 = 25 \mu s$ (Max.)

Critical Rate of Rise of On-State Current

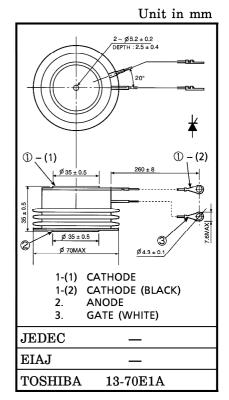
: $di/dt = 200A/\mu s$

Critical Rate of Rise of Off-State Voltage

 $: dv/dt = 500V/\mu s$

Weight : 480g

Flat Package



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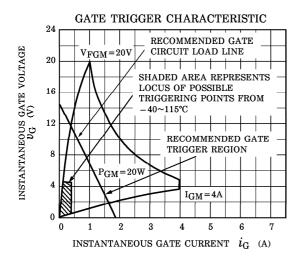
MAXIMUM RATINGS

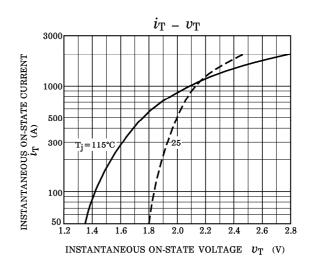
| CHARACTERISTIC | SYMBOL | SYMBOL | RATING | UNIT |
|---|--------------------------------------|---------------------------|----------------------------|----------------------|
| Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage | V _{DRM} V _{RRM} | $v_{ m DRM} \ v_{ m RRM}$ | 1300 | V |
| Non-Repetitive Peak Reverse Voltage (Non-Repetitive $< 5 \text{ms}, T_j = 0 \sim 115^{\circ}\text{C}$) | v_{RSM} | $v_{ m RSM}$ | 1400 | V |
| R.M.S On-State Current | I _T (RMS) | I _T (RMS) | 630 | Α |
| Average On-State Current | I _T (AV) | I _{T (AV)} | 400 | Α |
| Peak One Cycle Surge On-State Current (Non-Repetitive) | I _{TSM} | I_{TSM} | 8000 (50Hz) 8800 (60Hz) | A |
| I ² t Limit Value | ${f I^2 t}$ | ${f I^2 t}$ | 3.2×10^{5} | A^2 s |
| Critical Rate of Rise of On-State Current (Note) | di / dt | di / dt | 200 | A/μs |
| Peak Gate Power Dissipation | PGM | P_{GM} | 20 | W |
| Average Gate Power Dissipation | P _G (AV) | P _G (AV) | 4 | W |
| Peak Forward Gate Current | I_{GM} | $I_{\mathbf{GM}}$ | 4 | Α |
| Peak Forward Gate Voltage | V_{FGM} | $v_{ m FGM}$ | 20 | V |
| Peak Reverse Gate Voltage | v_{RGM} | V_{RGM} | 5 | V |
| Junction Temperature | T_{j} | T_{j} | -40~115 | °C |
| Storage Temperature Range | $\mathrm{T_{stg}}$ | $\mathrm{T_{stg}}$ | -40~115 | $^{\circ}\mathrm{C}$ |
| Mounting Force | _ | <u> </u> | 14.7 ± 1.5 | kN |

Note : V_D=650V, f=50Hz, T_j=110°C, Gate Supply (V_G=15V, R_G=8\Omega, t_r \le 1 \mu s)

ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC | SYMBOL | TEST CONDIT | MIN. | MAX. | UNIT | |
|---|-------------------------------------|---|--|------|------------|------|
| Repetitive Peak Off-State Current and Repetitive Peak Reverse Current | ${ m I}_{ m DRM}$ ${ m I}_{ m RRM}$ | $V_{ m DRM} = V_{ m RRM} = 1300 V$ $T_{ m j} = 115 ^{\circ} { m C}$ | | _ | 50 | mA |
| Peak On-State Voltage | $V_{	extbf{TM}}$ | $I_{TM} = 1250A, T_j = 25^{\circ}$ | | 2.2 | V | |
| Gate Trigger Voltage | v_{GT} | V6V P60 | $T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$ | | 4.5 3.5 | V |
| Gate Trigger Current | I_{GT} | $V_{\mathbf{D}} = 6V, R_{\mathbf{L}} = 6\Omega$ | $T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$ | _ | 400 260 | mA |
| Gate Non-Trigger Voltage | $v_{ m GD}$ | 77 AFOY M 11F0G | | 0.2 | _ | V |
| Gate Non-Trigger Current | I_{GD} | $V_{\rm D} = 650 \text{V}, T_{\rm j} = 115 ^{\circ} \text{C}$ | 5 | _ | mA | |
| Delay Time | $^{ m t_d}$ | $V_D = 650V$, $T_j = 25$ °C Gate Suppl | _ | 4 | μs | |
| Gate Turn-On Time | t_{gt} | $(V_G=15V, R_G=8\Omega)$ | _ | 6 | μs | |
| Turn-Off Time | t_{q} | I_{T} =800A, V_{R} \geq 50V dv / dt = 20V / \mu s, T_{j} =110°C V_{DRM} =650V | | _ | 25 | μs |
| Holding Current | I_{H} | $T_j=25$ °C, $R_L=6\Omega$ | | | 400 | mA |
| Critical Rate of Rise of Off-State Voltage | dv / dt | V _{DRM} =870V, T _j =115°C Gate Open, Exponential Rise | | 500 | _ | V/μs |
| Thermal Resistance (Junction to Case) | $ m R_{th~(j-f)}$ | DC | | _ | 0.05 | °C/W |





3/4

